

PATENT ASSIGNMENT COVER SHEET

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EPAS ID: PAT6486981

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
FEI DENG	01/07/2021
SILING YU	01/07/2021
YUFAN WANG	01/07/2021
YUANXIANG HUANG	01/07/2021
LINA WANG	01/07/2021
RECEIVING PARTY DATA	
Name:	SICHUAN TIANYI ECOLOGICAL GARDEN GROUP CO. LTD
Street Address:	NO.3,4, FLOOR 4, BLDG. 3, HAITE INT'L PLAZA,
Internal Address:	NO.1 KEYUAN SOUTH ROAD, HIGH TECH ZONE,
City:	CHENGDU, SICHUAN PROVINCE
State/Country:	CHINA
Postal Code:	610041
Name:	CHENGDU UNIVERSITY OF TECHNOLOGY
Street Address:	NO.1, EAST THIRD ROAD, ERXIANQIAO,
Internal Address:	CHENGHUA DISTRICT,
City:	CHENGDU, SICHUAN PROVINCE
State/Country:	CHINA
Postal Code:	610051
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	17144525
CORRESPONDENCE DATA	
Fax Number:	(571)282-6420
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
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PATENT

ATTORNEY DOCKET NUMBER:	CIP-200132-P-US-01
NAME OF SUBMITTER:	PIN PIN HUANG
SIGNATURE:	/PIN PIN HUANG/
DATE SIGNED:	01/08/2021
	This document serves as an Oath/Declaration (37 CFR 1.63).
Total Attachments: 2 source=DecAss#page1.tif source=DecAss#page2.tif	

Docket No.: _____

DECLARATION AND ASSIGNMENT FOR PATENT AND DESIGN APPLICATIONS

METHOD FOR SPLICING VECTOR POLYGON REGIONS WITH HOLES

(Title of Invention)

As a below named inventor, I hereby declare that:

This declaration is directed to:

☒ The attached application,

OR

☐ United States Application Number or PCT International Application number _____
filed on _____

The above-identified application was made or authorized to be made by me.

I believe that I am the original inventor or an original joint inventor of a claimed invention in the application.

I have reviewed and understand the contents of the above-identified application, including the claims.

I acknowledge the duty to disclose information which is material to patentability as defined in Title 37, Code of Federal Regulations § 1.56.

WHEREAS 1. Sichuan Tianyi Ecological Garden Group Co. Ltd
2. Chengdu University of Technology

1. No.3,4, Floor 4, Building 3, Haite International Plaza, No.1 Keyuan South Road,
High Tech Zone, Chengdu, Sichuan Province, China.

2. No.1, East Third Road, Erxianqiao, Chenghua District, Chengdu, Sichuan Province,

who's address is China.

hereinafter referred to as the assignee, is desirous of acquiring the entire right, title and interest in and to said application, including any and all divisions and continuations thereof, and in and to said invention and any and all patents which may be granted therefor, including any and all renewals, reissues and prolongations thereof.

NOW THIS WITNESSETH, that for a good and valuable consideration received by me, I hereby assigns, sells and transfers to said assignee, and said assignee's successors and assigns, the full and exclusive right, title and interest in and to said application, including any and all divisions and continuations thereof, and in and to said invention and any and all patents which may be granted therefore, including any and all renewals, reissues and prolongations thereof; said assignee, and said assignee's successors and assigns, to have, hold, exercise and enjoy the said application, including any and all divisions and continuations thereof, and the said invention and any and all patents which may be granted therefor, including any and all renewals, reissues and prolongations thereof, with all the rights, powers, privileges and advantages in anywise arising from or appertaining thereto, for and during the term or terms of any and all such patents when granted, including any and all renewals, reissues and prolongations thereof, for the use and benefit of said assignee, and said assignee's successors and assigns, in as ample and beneficial a manner as I might or could have held and enjoyed the same, if this assignment had not been made.

AND I hereby agree to perform, upon the request of said assignee, or said assignee's successors or assigns, any and all acts relating to the obtaining or to the asserting of said patents, including any and all renewals, reissues and prolongations thereof.

AND I authorize and requests the Commissioner of Patents and Trademarks to issue Letters Patent on said application, and on any and all divisions and continuations thereof, to said assignee, and said assignee's successors and assigns, in accordance herewith.

I hereby acknowledge that any willful false statement made in this declaration is punishable under 18 U.S.C. 1001 by fine or imprisonment of not more than five (5) years, or both.

Signature: _____

Fei Deng

Date: January 7, 2021

Legal Name of

Sole or First Inventor: Fei Deng

Signature: Siling Yu
Legal Name of
Sole or First Inventor: Siling Yu

Date: January 7, 2021

Signature: Yufan Wang
Legal Name of
Sole or First Inventor: Yufan Wang

Date: January 7, 2021

Signature: Yuanxiang Huang
Legal Name of
Sole or First Inventor: Yuanxiang Huang

Date: January 7, 2021

Signature: Lina Wang
Legal Name of
Sole or First Inventor: Lina Wang

Date: January 7, 2021